PHE844, Class X1, 440/480 VAC, 105°C



Overview

The PHE844 series is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material that meets the requirements of UL 94 V-0.

Applications

For use as an electromagnetic interference (EMI) suppression filter in across-the-line applications that require X1 safety classification. Suitable for use in situations in which capacitor failure does not pose a danger of electric shock.

Benefits

Approvals: ENEC, UL, cULClass X1 (IEC 60384-14)

 THB Grade IA: 40°C, 93% RH, 500 hours at 480 V URAC acc. to IEC 60384-14

 Rated voltage: 440 VAC 50/60 Hz (ENEC), 480 VAC 50/60 Hz (UL, cUL)

Capacitance range: 0.1 – 2.2 μF
Lead spacing: 22.5 – 37.5 mm
Capacitance tolerance: ±20%, ±10%

• Climatic category 40/105/56/B, IEC 60068-1

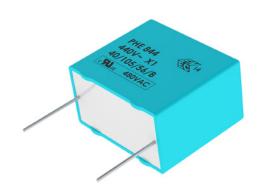
• Tape & Reel in accordance with IEC 60286-2

· RoHS Compliant and lead-free terminations

• Operating temperature range of -40°C to +105°C

• 100% screening factory test at 3,000 VDC

Self-healing properties



Customer Part Number

PHE844	R	D	6100	M	R06L2
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
X1, Metallized Polypropylene	R = 440	D = 22.5 F = 27.5 R = 37.5	The last three digits represent significant figures. The first digit specifies the total number of digits.	K = ±10% M = ±20%	See Ordering Options Table

KEMET Internal Part Number

F	844	D	Н	104	M	440	С
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Packaging
F = Film	X1, Metallized Polypropylene	D = 22.5 F = 27.5 R = 37.5	See Dimension Table	The first two digits represent significant figures. The third digit specifies number of zeros.	K = ±10% M = ±20%	440 = 440	See Ordering Options Table

Built Into Tomorrow



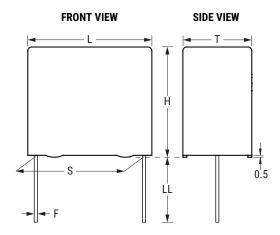
Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard Lead and Packaging Options			
	Bulk (Tray)-Short Leads	6 +0/-1	С	R06L2 ⁽¹⁾
	Other Lead and Packaging Options			
22.5	Pizza Pack	6 +0/-1	Z	R06L2 ⁽¹⁾
	Bulk (Tray)-Long Leads	30 +5/-0	ALW0L	R30L2
	Tape & Reel (Standard Reel)	H ₀ = 18.5 ±0.5	L	R17T0
	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	Р	R17T1
	Standard Lead and Packaging Options			
	Bulk (Tray)-Short Leads	6 +0/-1	С	R06L2 ⁽¹⁾
27.5	Other Lead and Packaging Options			
	Pizza Pack	6 +0/-1	Z	R06L2 ⁽¹⁾
	Bulk (Tray)-Long Leads	30 +5/-0	ALW0L	R30L2
	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	Р	R17T1
	Standard Lead and Packaging			
	Options			
37.5	Bulk (Tray)-Short Leads	6 +0/-1	С	R06L2 ⁽¹⁾
	Other Lead and Packaging Options			
	Pizza Pack	6 +0/-1	Z	R06L2 ⁽¹⁾

⁽¹⁾ Please specify Bulk (Tray) or Pizza Packaging



Dimensions - Millimeters



KEMET Size	Legacy Size		S		T		Н		L	F	
Code	Code	Nominal	Tolerance								
DH	D14	22.5	±0.4	8.0	Maximum	16.0	Maximum	26.0	Maximum	0.8	±0.05
DM	D15	22.5	±0.4	9.0	Maximum	18.5	Maximum	26.0	Maximum	0.8	±0.05
DT	D16	22.5	±0.4	11.0	Maximum	21.5	Maximum	26.0	Maximum	0.8	±0.05
DW	D20	22.5	±0.4	13.5	Maximum	23.0	Maximum	26.0	Maximum	0.8	±0.05
DY	D19	22.5	±0.4	15.5	Maximum	24.5	Maximum	26.0	Maximum	0.8	±0.05
FE	F11	27.5	±0.4	10.5	Maximum	20.5	Maximum	31.5	Maximum	0.8	±0.05
FK	F03	27.5	±0.4	13.5	Maximum	23.0	Maximum	31.5	Maximum	0.8	±0.05
FM	F13	27.5	±0.4	14.5	Maximum	24.5	Maximum	31.5	Maximum	0.8	±0.05
FR	F14	27.5	±0.4	17.5	Maximum	28.0	Maximum	31.5	Maximum	0.8	±0.05
FV	F16	27.5	±0.4	21.0	Maximum	30.0	Maximum	31.5	Maximum	0.8	±0.05
RF	R05	37.5	±0.5	13.0	Maximum	24.0	Maximum	41.0	Maximum	1.0	±0.05
RH	R04	37.5	±0.5	15.0	Maximum	26.0	Maximum	41.0	Maximum	1.0	±0.05
RM	R03	37.5	±0.5	19.0	Maximum	36.0	Maximum	41.0	Maximum	1.0	±0.05
RP	R06	37.5	±0.5	21.0	Maximum	38.0	Maximum	41.0	Maximum	1.0	±0.05
	Note: See the Ordering Options Table for lead length (LL) options.										



Performance Characteristics

Polypropylene film						
Metal layer deposited by evaporation under vacuum						
Non-inductive type. Series de	sign.					
Tinned wire						
Plastic case, thermosetting resi	in-filled. Box material is solve	nt-resistant and flame-retarda	nt according to UL94 V-0.			
440 VAC 50/60 Hz (ENEC) - 4	480 VAC 50/60 Hz (UL,cUL)					
0.10 - 2.2 μF						
E6 series (IEC 60063)						
±20% standard, ±10% option						
-40°C to 105°C						
40/105/56/B IEC 60068-1	40/105/56/B IEC 60068-1					
ENEC, UL, cUL						
EN/IEC 60384-14:2005, UL 60)384-14, CAN/CSA E60384-	14:09				
Maximum Values at +23°C						
Frequency	C ≤ 0.1 µF	0.1 μF < C ≤ 1 μF	C > 1 µF			
1 kHz	0.1%	0.1%	0.1%			
10 kHz	0.2%	0.4%	0.8%			
100 kHz	0.6%	-	-			
requirements in applicable equ	ipment standards. All electri	ical characteristics are check	ed after the test. Do not			
Tabulated Self-resonance Fre	quencies f _o (see Table 1 – F	Ratings & Part Number Refer	rence)			
-	Measured at +25°C ±5°C, ac	ccording to IEC 60384-2				
	Minimum Values Be	tween Terminals				
C ≤ 0.33	μF	C > 0.3	33 μF			
≥ 30,000	ΜΩ	≥ 10,000	MΩ • μF			
Recommended voltage ≤ 1,00	0 VDC					
	Non-inductive type. Series de Tinned wire Plastic case, thermosetting residud VAC 50/60 Hz (ENEC) - 40.10 - 2.2 µF E6 series (IEC 60063) ±20% standard, ±10% option -40°C to 105°C 40/105/56/B IEC 60068-1 ENEC, UL, cUL EN/IEC 60384-14:2005, UL 60 Frequency 1 kHz 10 kHz 100 kHz The 100% screening factory terrequirements in applicable equirepeat this test, as there is a risbeen repeated. Tabulated Self-resonance Free C ≤ 0.33 ≥ 30,000	Metal layer deposited by evaporation under vacuum Non-inductive type. Series design. Tinned wire Plastic case, thermosetting resin-filled. Box material is solve $440 \text{ VAC } 50/60 \text{ Hz } \text{ (ENEC)} - 480 \text{ VAC } 50/60 \text{ Hz } \text{ (UL,cUL)}$ $0.10 - 2.2 \mu\text{F}$ E6 series (IEC 60063) $\pm 20\%$ standard, $\pm 10\%$ option -40°C to 105°C $40/105/56/\text{B}$ IEC 60068-1 ENEC, UL, cUL EN/IEC 60384-14:2005, UL 60384-14, CAN/CSA E60384- Maximum Value Frequency $C \le 0.1 \mu\text{F}$ 1kHz 0.1% 10kHz 0.6% The 100% screening factory test is carried out at 3,000 VDC requirements in applicable equipment standards. All electric repeat this test, as there is a risk of damaging the capacitor been repeated. Tabulated Self-resonance Frequencies f_o (see Table 1 – 6) Measured at $+25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, and	Metal layer deposited by evaporation under vacuum Non-inductive type. Series design. Tinned wire Plastic case, thermosetting resin-filled. Box material is solvent-resistant and flame-retarda 440 VAC 50/60 Hz (ENEC) − 480 VAC 50/60 Hz (UL,cUL) $0.10 - 2.2 \mu F$ E6 series (IEC 60063) $\pm 20\%$ standard, $\pm 10\%$ option -40°C to 105°C $40/105/56/B$ IEC 60068-1 ENEC, UL, cUL EN/IEC 60384-14:2005, UL 60384-14, CAN/CSA E60384-14:09 Maximum Values at $\pm 23^{\circ}\text{C}$ Frequency $C \le 0.1 \mu F$ 1kHz 0.1% 10kHz 0.2% 0.4% 100kHz 0.6% The 100% screening factory test is carried out at 3,000 VDC. The voltage level is selecter requirements in applicable equipment standards. All electrical characteristics are check repeat this test, as there is a risk of damaging the capacitor. KEMET is not liable for any fibeen repeated. Tabulated Self-resonance Frequencies f_{\circ} (see Table 1 − Ratings & Part Number Reference of the surface of			



Environmental Test Data

Test	IEC Publication	Procedure				
Endurance	IEC 60384-14:2005	$1.25 \times V_R$ VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature				
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s ² No visible damage. No open or short circuit.				
Bump	IEC 60068-2-29 Test Eb	1,000 bumps at 390 m/s ² No visible damage. No open or short circuit.				
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles No visible damage.				
Active Flammability	IEC 60384-14:2005	V _R + 20 surge pulses at 4 kV (pulse every 5 seconds)				
Passive Flammability	IEC 60384-14:2005	IEC 60384-1, IEC 60695-11-5 Needle Flame Test				
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 90 - 95% RH, 56 days				
THB Test	According to Grade IA	+40°C and 90 - 95% RH, 21 days at rated AC-voltage Capacitance change (ΔC/C): ≤ 10% Dissipation factor change (Δtan δ): ≤ 24 * 10 ⁻³ (at 10 kHz) for C ≤ 1 μF Dissipation factor change (Δtan δ): ≤ 15 * 10 ⁻³ (at 1 kHz) for C > 1 μF Insulation resistance IR in seconds or time constant τ = CR Rins: ≥ 50% of initial limit				

Approvals

Certification Body	Mark	Specification	File Number
Intertek Semko AB		EN/IEC 60384-14	SE/0140-1D
UL	c FL us	UL 60384 and CAN/CSA E60384-14:09 (480 VAC)	E73869

Environmental Compliance

All KEMET EMI capacitors are RoHS compliant.





Table 1 - Ratings & Part Number Reference

Capacitance Value (µF)	Size Code (KEMET/		laximur nsions i		Lead Spacing (S)	f _o (MHz)	dV/dt (V/	KEMET Part Number	Legacy Part Number
raide (pr.)	Legacy)	T	Н	L	opuomig (o)	(11112)	µs)	T di C T di li boi	T di t i tallisci
0.10	DH/D14	8.0	16.0	26.0	22.5	3.2	100	F844DH104(1)440(2)	PHE844RD6100(1)(2)
0.15	DM/D15	9.0	18.5	26.0	22.5	2.6	100	F844DM154(1)440(2)	PHE844RD6150(1)(2)
0.22	DT/D16	11.0	21.5	26.0	22.5	2.1	100	F844DT224(1)440(2)	PHE844RD6220(1)(2)
0.33	DW/D20	13.5	23.0	26.0	22.5	1.8	100	F844DW334(1)440(2)	PHE844RD6330(1)(2)
0.47	DY/D19	15.5	24.5	26.0	22.5	1.5	100	F844DY474(1)440(2)	PHE844RD6470(1)(2)
0.22	FE/F11	10.5	20.5	31.5	27.5	2.2	100	F844FE224(1)440(2)	PHE844RF6220(1)(2)
0.33	FK/F03	13.5	23.0	31.5	27.5	1.7	100	F844FK334(1)440(2)	PHE844RF6330(1)(2)
0.47	FM/F13	14.5	24.5	31.5	27.5	1.4	100	F844FM474(1)440(2)	PHE844RF6470(1)(2)
0.68	FR/F14	17.5	28.0	31.5	27.5	1.1	100	F844FR684(1)440(2)	PHE844RF6680(1)(2)
1.0	FV/F16	21.0	30.0	31.5	27.5	1.0	100	F844FV105(1)440(2)	PHE844RF7100(1)(2)
0.47	RF/R05	13.0	24.0	41.0	37.5	1.3	100	F844RF474(1)440(2)	PHE844RR6470(1)(2)
0.68	RF/R05	13.0	24.0	41.0	37.5	1.1	100	F844RF684(1)440(2)	PHE844RR6680(1)(2)
1.0	RH/R04	15.0	26.0	41.0	37.5	0.92	100	F844RH105(1)440(2)	PHE844RR7100(1)(2)
1.5	RM/R03	19.0	36.0	41.0	37.5	0.74	100	F844RM155(1)440(2)	PHE844RR7150(1)(2)
2.2	RP/R06	21.0	38.0	41.0	37.5	0.60	100	F844RP225(1)440(2)	PHE844RR7220(1)(2)
Capacitance Value (µF)	Size Code (KEMET/Legacy)	T (mm)	H (mm)	L (mm)	Lead Spacing (S)	f _o (MHz)	dV/dt (V/μs)	KEMET Part Number	Legacy Part Number

⁽¹⁾ $M = \pm 20\%$, $K = \pm 10\%$.

⁽²⁾ Insert ordering code for lead type and packaging. See the Ordering Options Table for available options.



Soldering Process

The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder. This implementation has increased the liquidus temperature from 183°C for SnPb eutectic alloys to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 – 15 mm), and great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

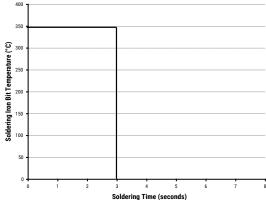
Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the recommended limits may result in degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface-mount components. Insert through-hole parts after curing the surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum of two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal before the second soldering cycle.

Manual Soldering Recommendations

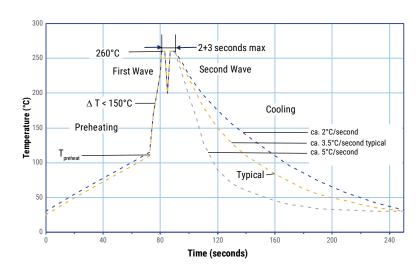
Following is the recommendation for manual soldering with a soldering iron.





Soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed 3 seconds.

Wave Soldering Recommendations





Soldering Process cont.

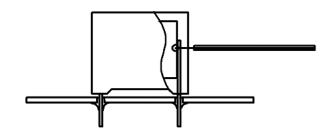
Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process. Figure 1

Dielectric film material		n Preheat erature	Maximum Peak Soldering Temperature			
	Capacitor Pitch ≥ 10 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm		
Polyester	130°C	130°C	270°C	270°C		
Polypropylene	110°C	130°C	260°C	270°C		
Paper	130°C	140°C	270°C	270°C		
Polyphenylene Sulphide	150°C	160°C	270°C	270°C		

2. The maximum temperature measured inside the capacitor: set the temperature so that the maximum temperature is below the limit inside the element.

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

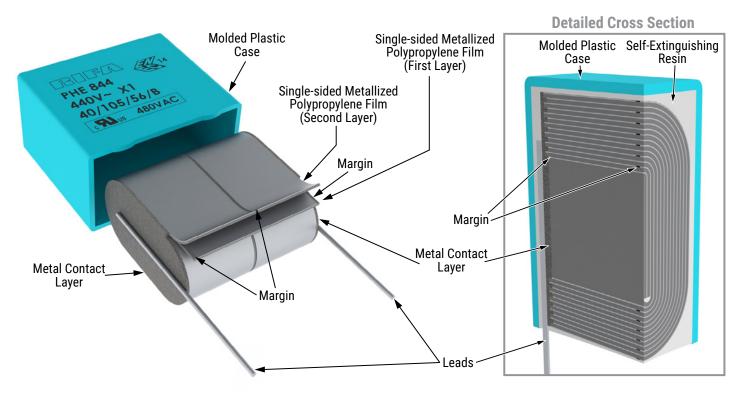
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath, as in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and then pressed against the lower surface of the board to solder the components.

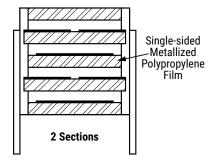
The temperature profile for selective soldering is similar to the double-wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double-wave flow soldering. Great care must be taken so that the parts do not overheat.



Construction

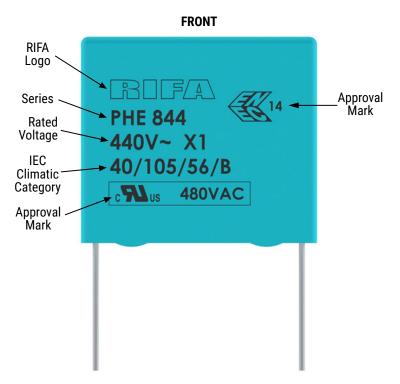


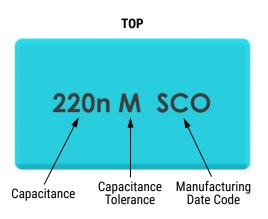
Winding Scheme





Marking





Mar	Manufacturing Date Code (IEC-60062)								
Year	Code	Month	Code						
2020	М	January	1						
2021	N	February	2						
2022	Р	March	3						
2023	R	April	4						
2024	S	May	5						
2025	Т	June	6						
2026	U	July	7						
2027	V	August	8						
2028	W	September	9						
2029	Х	October	0						
2030	А	November	N						
2031	В	December	D						
2032	С								
2033	D								
2034	E								
2035	F								
2036	Н								
2037	J								
2038	К								
2039	L								
2040	М								



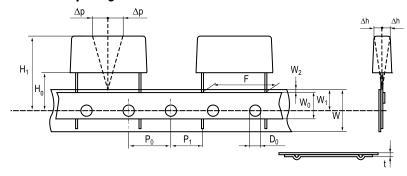
Packaging Quantities

Lead Spacing	KEMET Size Code	Legacy Size Code	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Bulk (Pizza)
	DD	D13	6.5	14.5	26.0	234	300	600	440
	DH	D14	8.0	16.0	26.0	186	250	500	352
	DM	D15	9.0	18.5	26.0	308	250	500	308
22 E	DT	D16	11.0	21.5	26.0	253	200	400	253
22.5	DF	D17	7.0	16.5	26.0	216	300	600	396
	DR	D18	10.5	19.0	26.0	264	200	400	264
	DY	D19	15.5	24.5	26.0	176	110	250	176
	DW	D20	13.5	23.0	26.0	209	160	300	209
	l FK	F03	13.5	23.0	31.5	171		250	171
	FE	F11	10.5	20.5	31.5	216		350	216
	FG	F12	11.5	22.5	31.5	198		300	198
	FM	F13	14.5	24.5	31.5	153		250	153
07.5	FR	F14	17.5	28.0	31.5	126			126
27.5	FS	F15	19.0	29.0	31.5	117			117
	FV	F16	21.0	30.0	31.5	108			108
	FH	F17	21.0	12.5	31.5	108			108
	FT	F18	31.0	18.5	31.5	72			72
	FQ	F19	27.5	16.0	31.5	81			81
	l DV	DOO	16 F	22.0	41.0	105			105
	RK	R02	16.5	32.0	41.0	105			105
	RM	R03	19.0	36.0	41.0	91			91
37.5	RH	R04	15.0	26.0	41.0	119			119
	RF	R05	13.0	24.0	41.0	140			140
	RP	R06	21.0	38.0	41.0	84			84
	RS	R08	28.0	43.0	41.0	54			54



Lead Taping & Packaging (IEC 60286-2)

Lead Spacing 22.5 - 27.5 mm



Taping Specification

Description	Symbol	Dimensions (mm)		
		Lead Space		Tolerance
		22.5	27.5	Tolerance
Lead Spacing	F	22.5	27.5	+0.6/-0.1
Carrier Tape Width	W	18	18	+1/-0.5
Hold Down Tape Width	W _o	5	5	Minimum
Hole Position	W ₁	9	9	+0.75/-0.5
Hold Down Tape Position	W ₂	3	3	Maximum
Feed Hole Diameter	D ₀	4	4	±0.2
Feed-hole Lead Space *	P ₀	12.7	12.7	±0.2 **
Centering of the Lead Wire	P ₁	7.8	5.3	±0.7
Component Alignment	Δh	2	2	±2
Deviation Tape - Plane	Δр	1.3	1.3	Maximum
Tape Thickness	t	0.9	0.9	Maximum
Height of Component from Tape Center	H ₀ ***	18.5	18.5	±0.5

^{*}Available also 15mm

^{**}Maximum 1 mm on 20 lead spaces

^{***} H_0 = 16.5 mm is available upon request



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Additional information about production site flexibility can be found <here>